

DATA SHEET

74ABT648 Octal transceiver/register, inverting (3-State)

Product specification
Supersedes data of 1995 Apr 17
IC23 Data Handbook

1998 Jun 08

Octal bus transceiver/register, inverting (3-State)**74ABT648****FEATURES**

- Combines 74ABT245 and 74ABT374 type functions in one device
- Independent registers for A and B buses
- Multiplexed real-time and stored data
- Output capability: +64mA/-32mA
- Power-up 3-state
- Power-up reset
- Live insertion/extraction permitted
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model

DESCRIPTION

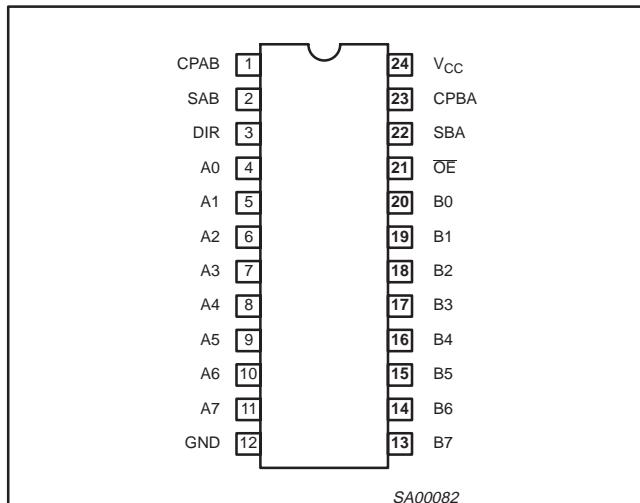
The 74ABT648 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS $T_{amb} = 25^\circ\text{C}$; GND = 0V	TYPICAL	UNIT
t_{PLH} t_{PHL}	Propagation delay An to Bn or Bn to An	$C_L = 50\text{pF}$; $V_{CC} = 5\text{V}$	5.9	ns
C_{IN}	Input capacitance CP, S, \overline{OE} , DIR	$V_I = 0\text{V}$ or V_{CC}	4	pF
$C_{I/O}$	I/O capacitance	Outputs disabled; $V_O = 0\text{V}$ or V_{CC}	7	pF
I_{CCZ}	Total supply current	Outputs disabled; $V_{CC} = 5.5\text{V}$	110	μA

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
24-Pin Plastic DIP	-40°C to +85°C	74ABT648 N	74ABT648 N	SOT222-1
24-Pin plastic SO	-40°C to +85°C	74ABT648 D	74ABT648 D	SOT137-1
24-Pin Plastic SSOP Type II	-40°C to +85°C	74ABT648 DB	74ABT648 DB	SOT340-1
24-Pin Plastic TSSOP Type I	-40°C to +85°C	74ABT648 PW	74ABT648PW DH	SOT355-1

PIN CONFIGURATION

SA00082

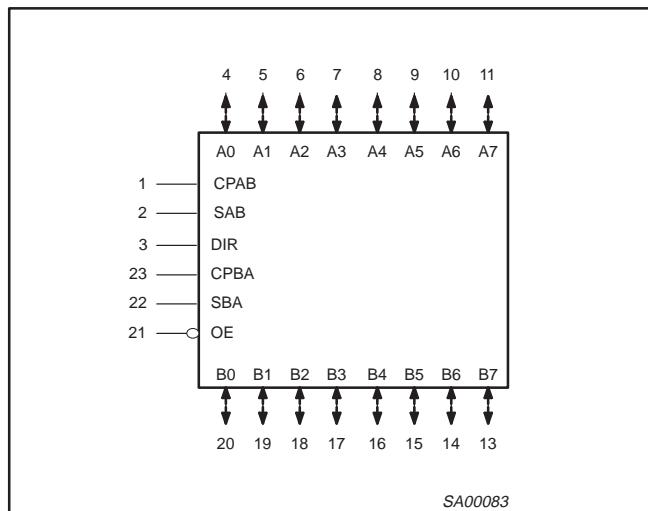
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
1, 23	CPAB / CPBA	A to B clock input / B to A clock input
2, 22	SAB / SBA	A to B select input / B to A select input
3	DIR	Direction control input
4, 5, 6, 7, 8, 9, 10, 11	A0 – A7	Data inputs/outputs (A side)
20, 19, 18, 17, 16, 15, 14, 13	B0 – B7	Data inputs/outputs (B side)
21	\overline{OE}	Output enable input (active-Low)
12	GND	Ground (0V)
24	V_{CC}	Positive supply voltage

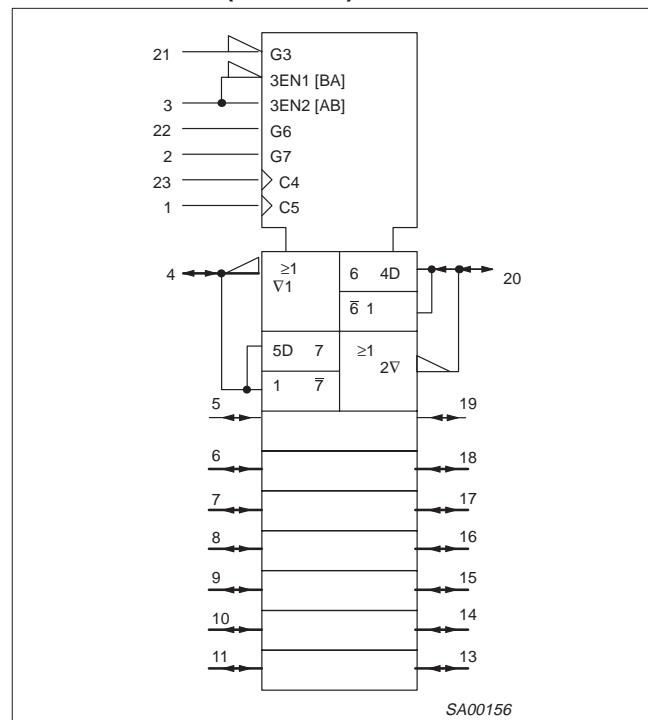
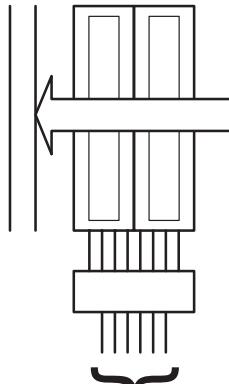
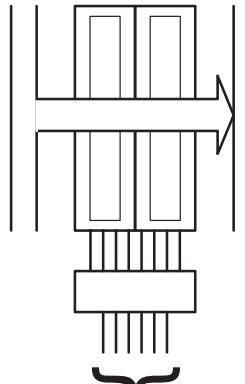
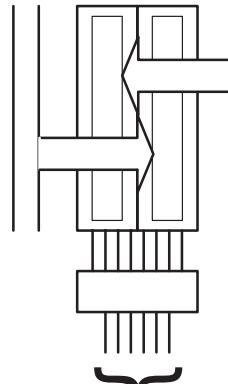
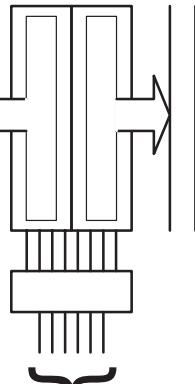
Octal bus transceiver/register, inverting (3-State)

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LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)

REAL TIME BUS TRANSFER
BUS B TO BUS AREAL TIME BUS TRANSFER
BUS A TO BUS BSTORAGE FROM
A, B, OR A AND BTRANSFER STORED DATA
TO A OR B

OE	DIR	CPAB	CPBA	SAB	SBA
L	L	X	X	X	L

OE	DIR	CPAB	CPBA	SAB	SBA
L	H	X	X	L	X

OE	DIR	CPAB	CPBA	SAB	SBA
L	H	↑	X	L	X
L	X	X	↑	X	X
H	X	↑	↑	X	X

OE	DIR	CPAB	CPBA	SAB	SBA	
L	L	H	Or	L	X	H
L	H	H	Or	L	X	H

SA00177

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FUNCTION TABLE

INPUTS					DATA I/O		OPERATING MODE
OE	DIR	CPAB	CPBA	SAB SBA	An	Bn	
X	X	↑	X	X X	Input	Unspecified output*	Store A, B unspecified
X	X	X	↑	X X	Unspecified output*	Input	Store B, A unspecified
H H	X	↑ H or L	↑ H or L	X X	Input	Input	Store A and B data Isolation, hold storage
L L	L	X H or L	X H or L	X L	Output	Input	Real time \bar{B} data to A bus Stored \bar{B} data to A bus
L L	H	X H or L	X X	L X	Input	Output	Real time \bar{A} data to B bus Stored \bar{A} data to B bus

H = High voltage level

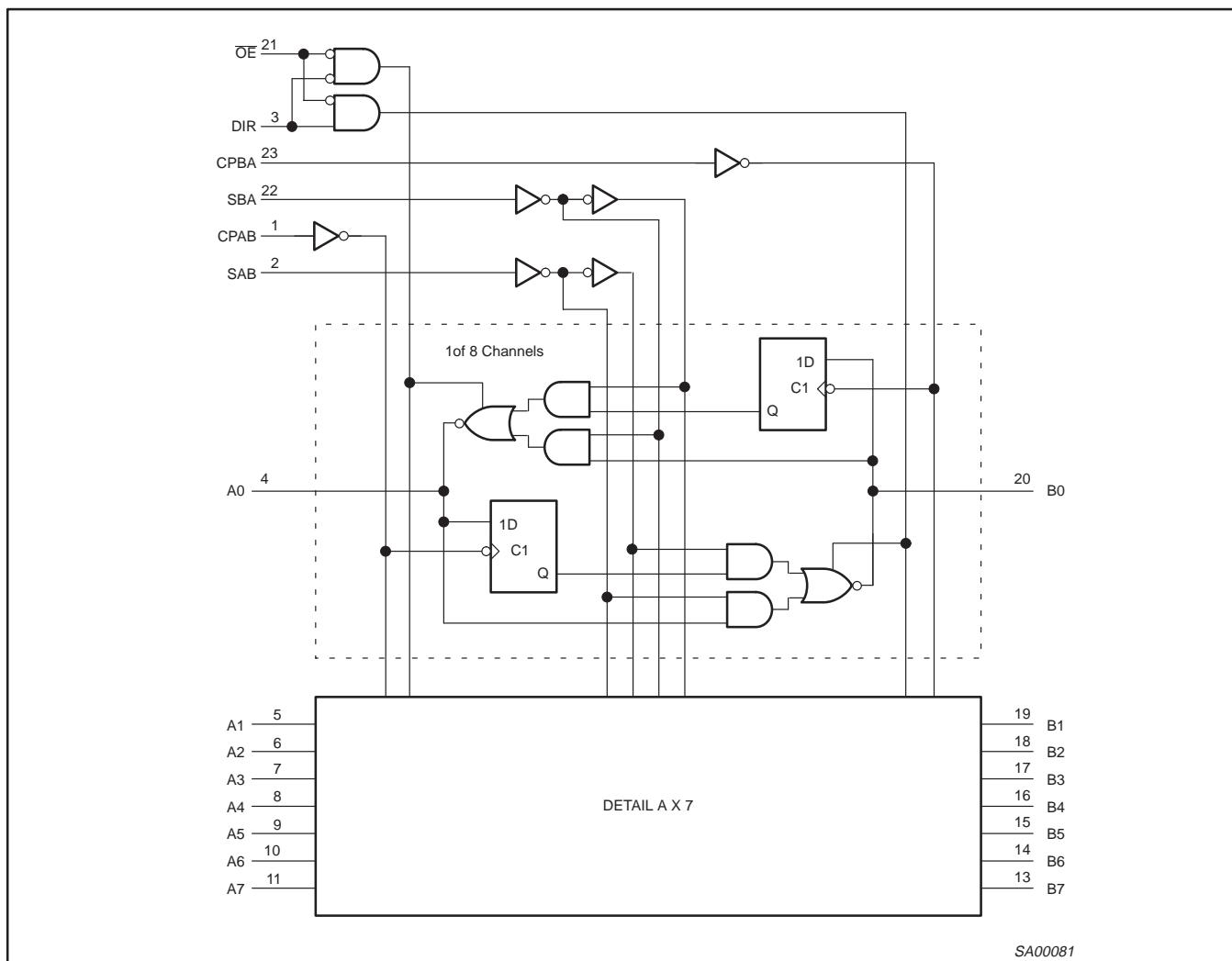
L = Low voltage level

X = Don't care

↑ = Low-to-High clock transition

* The data output function may be enabled or disabled by various signals at the OE input. Data input functions are always enabled, i.e., data at the bus pins will be stored on every Low-to-High transition of the clock.

LOGIC DIAGRAM



Octal bus transceiver/register, inverting (3-State)

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		−0.5 to +7.0	V
I_{IK}	DC input diode current	$V_I < 0$	−18	mA
V_I	DC input voltage ³		−1.2 to +7.0	V
I_{OK}	DC output diode current	$V_O < 0$	−50	mA
V_{OUT}	DC output voltage ³	output in Off or High state	−0.5 to +5.5	V
I_{OUT}	DC output current	output in Low state	128	mA
T_{stg}	Storage temperature range		−65 to 150	°C

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
3. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIMITS		UNIT
		Min	Max	
V_{CC}	DC supply voltage	4.5	5.5	V
V_I	Input voltage	0	V_{CC}	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Low-level Input voltage		0.8	V
I_{OH}	High-level output current		−32	mA
I_{OL}	Low-level output current		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_{amb}	Operating free-air temperature range	−40	+85	°C

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DC ELECTRICAL CHARACTERISTICS

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT	
			T _{amb} = +25°C			T _{amb} = -40°C to +85°C			
			Min	Typ	Max	Min	Max		
V _{IK}	Input clamp voltage	V _{CC} = 4.5V; I _{IK} = -18mA		-0.9	-1.2		-1.2	V	
V _{OH}	High-level output voltage	V _{CC} = 4.5V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH}	2.5	3.2		2.5		V	
		V _{CC} = 5.0V; I _{OH} = -3mA; V _I = V _{IL} or V _{IH}	3.0	3.7		3.0		V	
		V _{CC} = 4.5V; I _{OH} = -32mA; V _I = V _{IL} or V _{IH}	2.0	2.3		2.0		V	
V _{RST}	Power-up output low voltage ³	V _{CC} = 5.5V; I _O = 1mA; V _I = GND or V _{CC}		0.13	0.55		0.55	V	
V _{OL}	Low-level output voltage	V _{CC} = 4.5V; I _{OL} = 64mA; V _I = V _{IL} or V _{IH}		0.42	0.55		0.55	V	
I _{OFF}	Power-off leakage current	V _{CC} = 0.0V; V _I or V _O ≤ 4.5V		±5.0	±100		±100	µA	
I _{PU/PD}	Power-up/down 3-State output current ⁴	V _{CC} = 2.1V; V _O = 0.5V; V _I = GND or V _{CC} ; V _{OE} = Don't care		±5.0	±50		±50	µA	
I _I	Input leakage current	Control pins	V _{CC} = 5.5V; V _I = GND or 5.5V		±0.01	±1.0		±1.0	µA
		Data pins	V _{CC} = 5.5V; V _I = GND or 5.5V		±5	±100		±100	µA
I _{IH} + I _{OZH}	3-State output High current	V _{CC} = 5.5V; V _O = 2.7V; V _I = V _{IL} or V _{IH}		5.0	50		50	µA	
I _{IL} + I _{OZL}	3-State output Low current	V _{CC} = 5.5V; V _O = 0.5V; V _I = V _{IL} or V _{IH}		-5.0	-50		-50	µA	
I _{CEX}	Output high leakage current	V _{CC} = 5.5V; V _O = 5.5V; V _I = GND or V _{CC}		5.0	50		50	µA	
I _O	Output current ¹	V _{CC} = 5.5V; V _O = 2.5V	-50	-65	-180	-50	-180	mA	
I _{CCH}	Quiescent supply current	V _{CC} = 5.5V; Outputs High, V _I = GND or V _{CC}		110	250		250	µA	
I _{CCL}		V _{CC} = 5.5V; Outputs Low, V _I = GND or V _{CC}		20	30		30	mA	
I _{CCZ}		V _{CC} = 5.5V; Outputs 3-State; V _I = GND or V _{CC}		110	250		250	µA	
ΔI _{CC}	Additional supply current per input pin ²	V _{CC} = 5.5V; one input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V		0.3	1.5		1.5	mA	

NOTES:

1. Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
2. This is the increase in supply current for each input at 3.4V.
3. For valid test results, data must not be loaded into the flip-flops (or latches) after applying the power.
4. This parameter is valid for any V_{CC} between 0V and 2.1V, with a transition time of up to 10msec. From V_{CC} = 2.1 to V_{CC} = 5V ± 10% a transition time of up to 100µsec is permitted.

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AC CHARACTERISTICS

GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	LIMITS					UNIT	
			$T_{amb} = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$			$T_{amb} = -40 \text{ to } +85^\circ\text{C}$ $V_{CC} = +5.0\text{V} \pm 0.5\text{V}$			
			Min	Typ	Max	Min	Max		
f_{MAX}	Maximum clock frequency	1	125	200		125		MHz	
t_{PLH} t_{PHL}	Propagation delay CPAB to Bn or CPBA to An	1	2.2 1.7	5.3 5.9	6.8 7.4	2.2 1.7	7.8 8.4	ns	
t_{PLH} t_{PHL}	Propagation delay An to Bn or Bn to An	2 3	1.0 1.5	3.6 4.2	5.1 5.6	1.0 1.5	6.1 6.3	ns	
t_{PLH} t_{PHL}	Propagation delay SAB to Bn or SBA to An	2 3	1.5 1.5	4.9 5.4	6.1 6.9	1.5 1.5	7.1 7.7	ns	
t_{PZH} t_{PZL}	Output enable time OE to An or Bn	5 6	1.0 2.1	4.3 5.5	5.3 7.4	1.0 2.1	6.3 8.8	ns	
t_{PHZ} t_{PLZ}	Output disable time OE to An or Bn	5 6	1.5 1.5	6.2 6.0	7.3 7.0	1.5 1.5	8.3 7.5	ns	
t_{PZH} t_{PZL}	Output enable time DIR to An or Bn	5 6	1.2 2.5	4.8 6.0	5.7 9.0	1.2 2.5	6.7 9.5	ns	
t_{PHZ} t_{PLZ}	Output disable time DIR to An or Bn	5 6	1.5 1.5	5.9 6.3	6.7 7.2	1.5 1.5	7.7 8.2	ns	

AC SETUP REQUIREMENTS

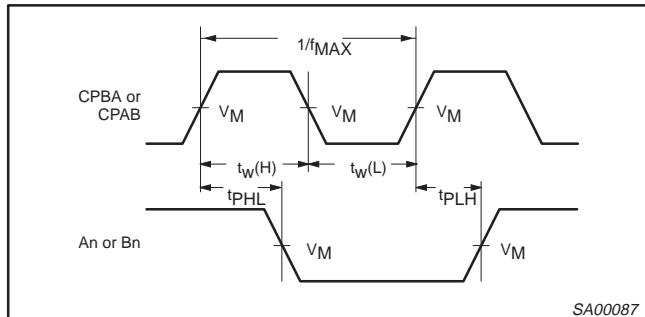
GND = 0V, $t_R = t_F = 2.5\text{ns}$, $C_L = 50\text{pF}$, $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	LIMITS			UNIT
			$T_{amb} = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$		$T_{amb} = -40 \text{ to } +85^\circ\text{C}$ $V_{CC} = +5.0\text{V} \pm 0.5\text{V}$	
			Min	Typ	Min	
$t_s(H)$ $t_s(L)$	Setup time An to CPAB, Bn to CPBA	4	3.0 3.0	1.5 1.0	3.0 3.0	ns
$t_h(H)$ $t_h(L)$	Hold time An to CPAB, Bn to CPBA	4	0.0 0.0	-0.4 -1.0	0.0 0.0	ns
$t_w(H)$ $t_w(L)$	Pulse width, High or Low CPAB or CPBA	1	3.5 4.0	2.6 1.0	3.5 4.0	ns

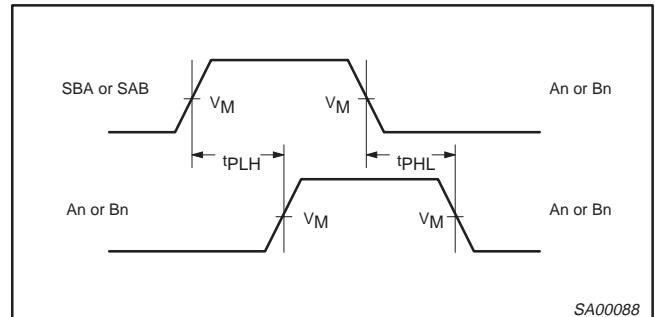
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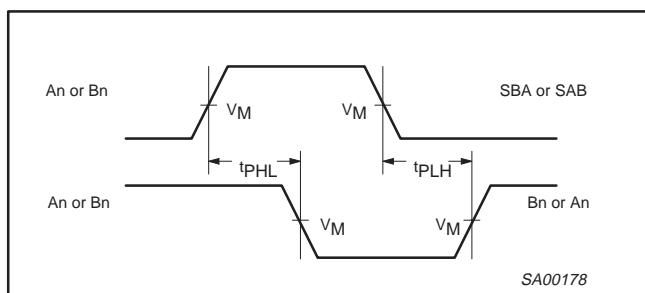
AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to $3.0V$ 

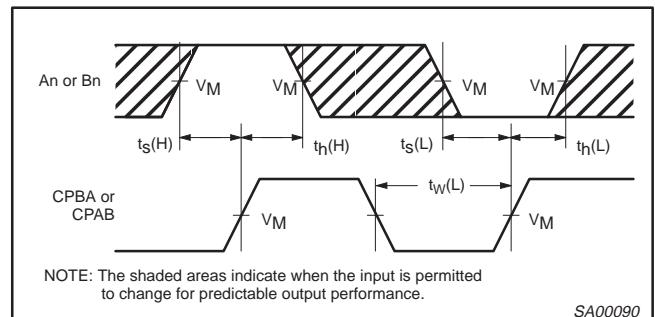
Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency



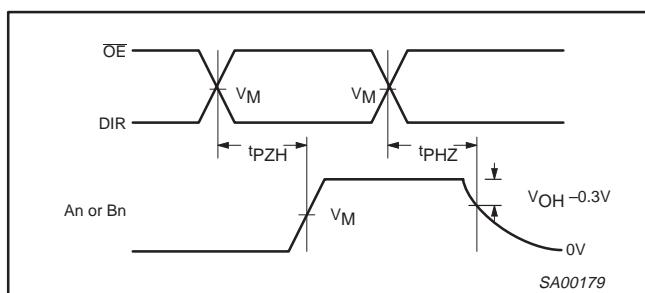
Waveform 2. Propagation Delay, SAB to Bn or SBA to An



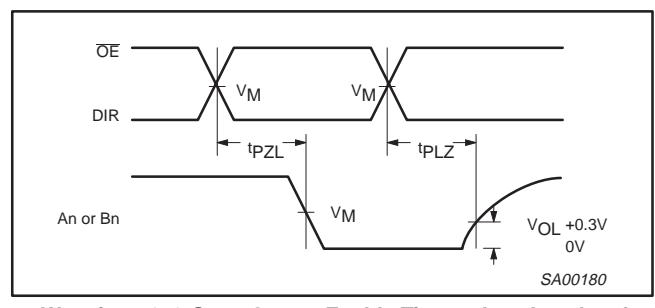
Waveform 3. Propagation Delay, An to Bn or Bn to An and SBA to An or SAB to Bn



Waveform 4. Data Setup and Hold Times



Waveform 5. 3-State Output Enable Time to High Level and Output Disable Time from High Level

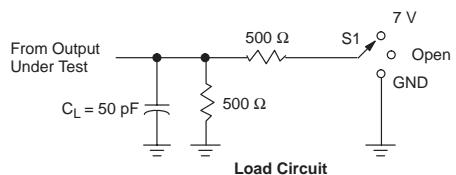


Waveform 6. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

Octal bus transceiver/register, inverting (3-State)

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TEST CIRCUIT AND WAVEFORM



TEST	S1
t_{pd}	open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	open

DEFINITIONS

C_L = Load capacitance includes jig and probe capacitance;
see AC CHARACTERISTICS for value.

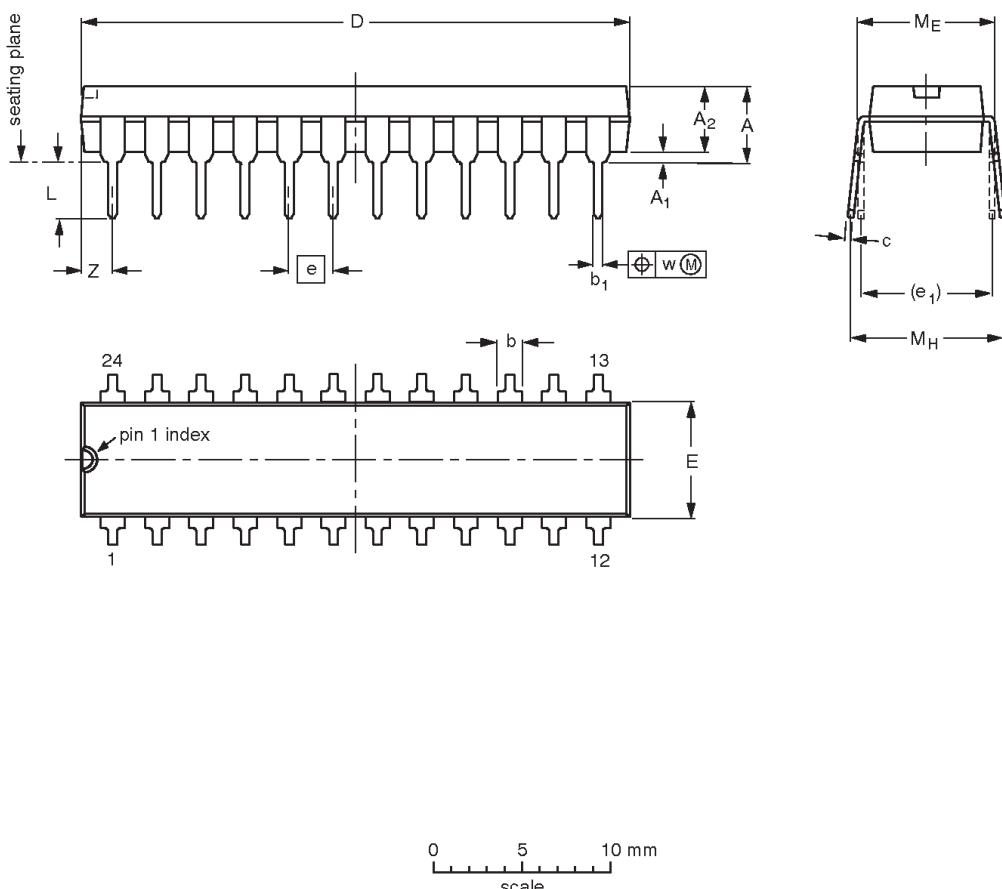
SA00012

Octal bus transceiver/register, inverting (3-State)

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DIP24: plastic dual in-line package; 24 leads (300 mil)

SOT222-1



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.70	0.38	3.94	1.63 1.14	0.56 0.43	0.36 0.25	31.9 31.5	6.73 6.48	2.54	7.62	3.51 3.05	8.13 7.62	10.03 7.62	0.25	2.05
inches	0.185	0.015	0.155	0.064 0.045	0.022 0.017	0.014 0.010	1.256 1.240	0.265 0.255	0.100	0.300	0.138 0.120	0.32 0.30	0.395 0.300	0.01	0.081

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

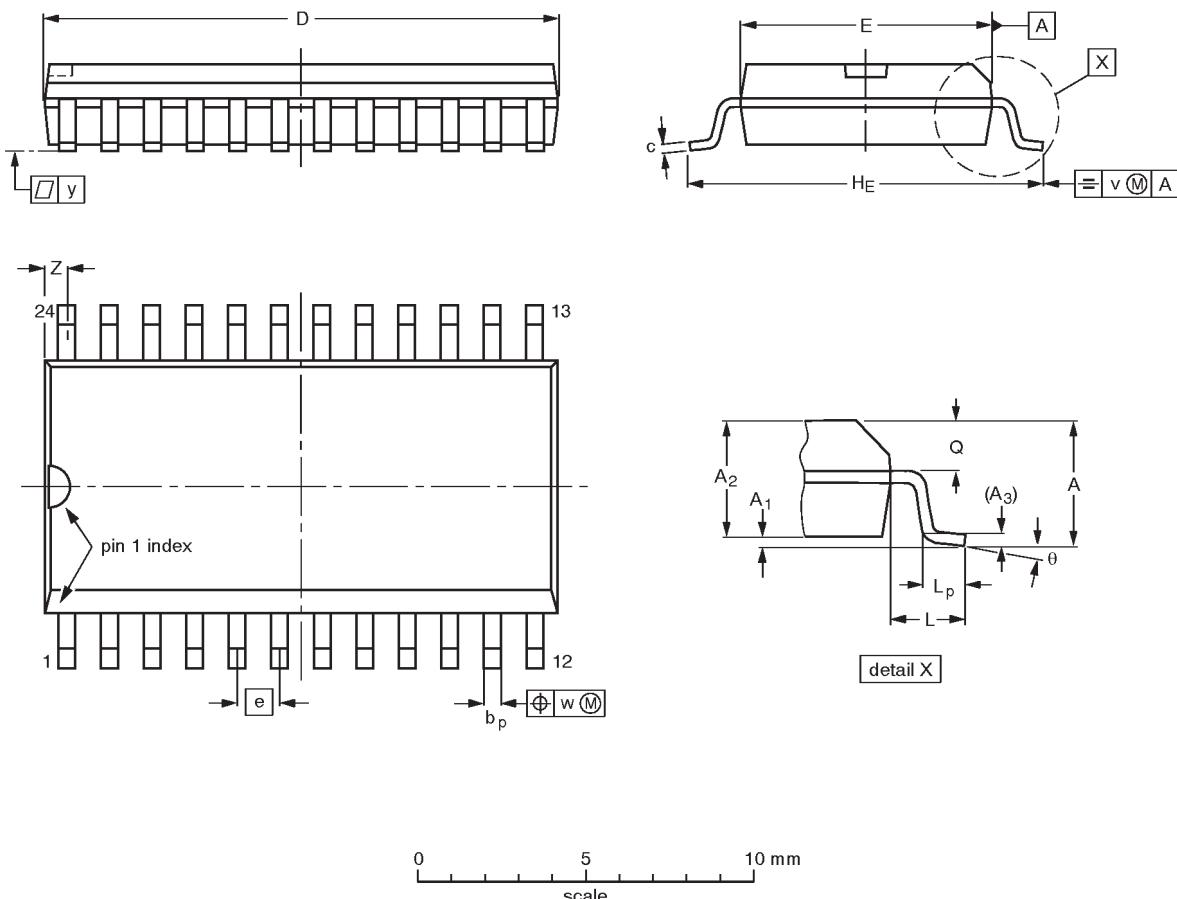
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT222-1		MS-001AF				95-03-11

Octal bus transceiver/register, inverting (3-State)

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SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.65 0.10	0.30 0.25	2.45 2.25	0.25	0.49 0.36	0.32 0.23	15.6 15.2	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10 0.004	0.012 0.089	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.61 0.60	0.30 0.29	0.050	0.42 0.39	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

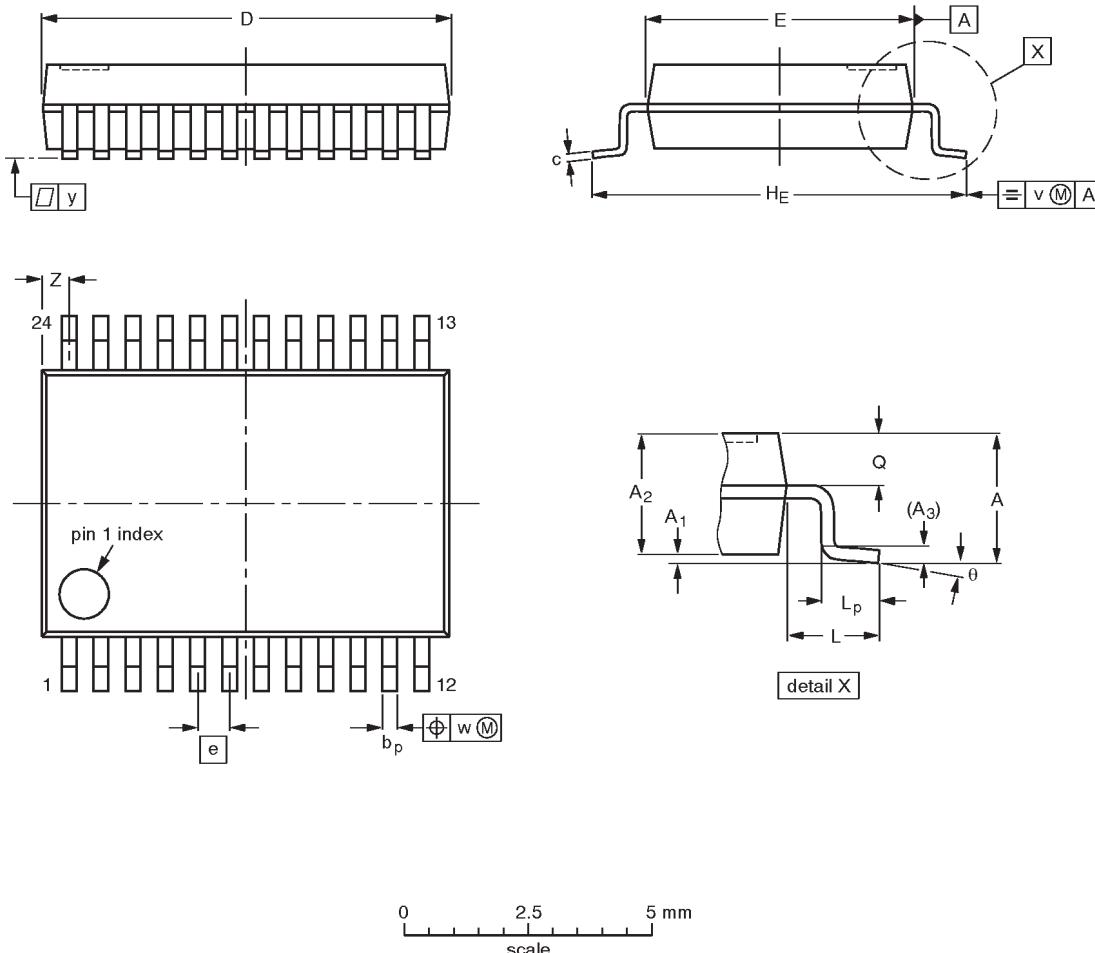
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT137-1	075E05	MS-013AD				92-11-17 95-01-24

Octal bus transceiver/register, inverting (3-State)

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SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	2.0 0.05	0.21 1.65	1.80	0.25	0.38 0.25	0.20 0.09	8.4 8.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.8 0.4	8° 0°

Note

1. Plastic or metal protrusions of 0.20 mm maximum per side are not included.

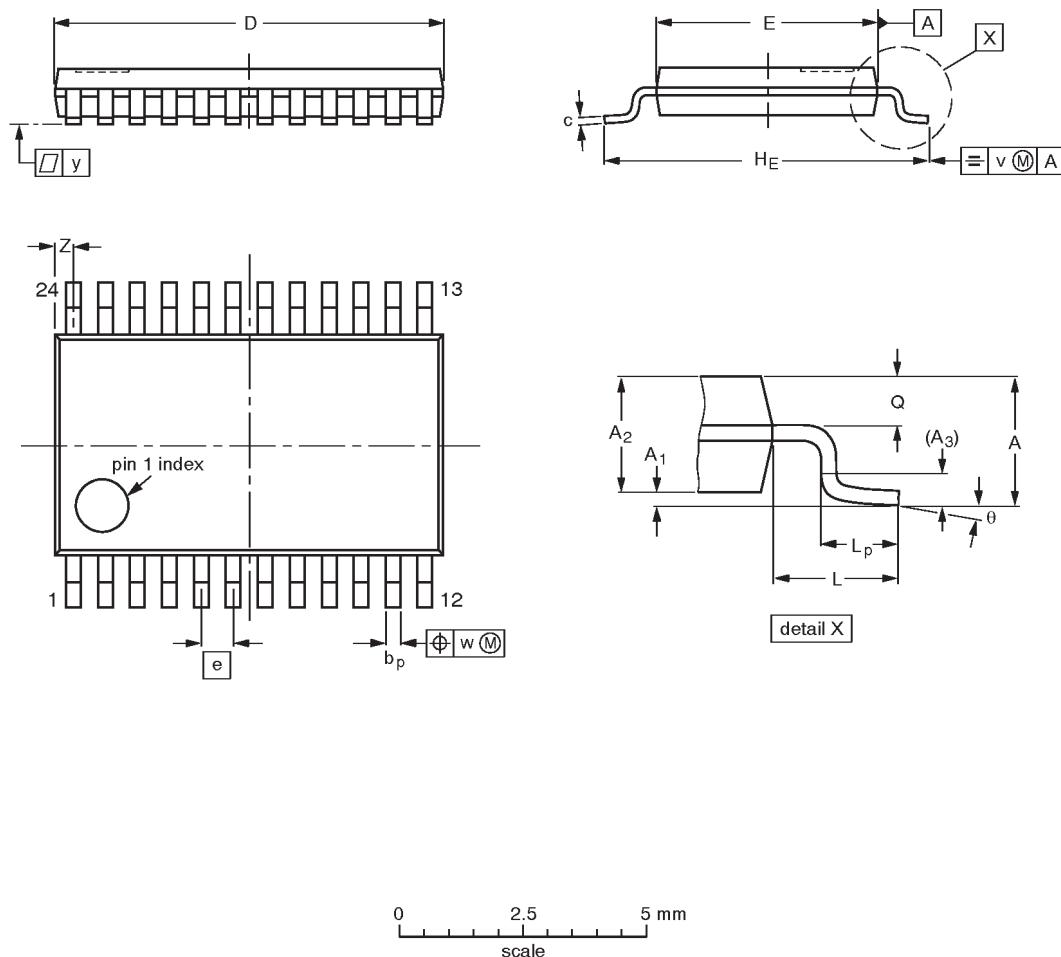
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT340-1		MO-150AG				93-09-08 95-02-04

Octal bus transceiver/register, inverting (3-State)

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TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.10 0.05	0.15 0.080	0.95	0.25 0.19	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT355-1		MO-153AD				-93-06-16 95-02-04

Octal transceiver/register, inverting (3-State)

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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